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TinyLogic UHS Dual Buffer

NC7WZ16

Description

The NC7WZ16 is a dual buffer from onsemi's Ultra-High Speed Series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive while maintaining low static power dissipation over a very broad V_{CC} operating range. The device is specified to operate over the 1.65 V to 5.5 V V_{CC} range. The inputs and outputs are high impedance when V_{CC} is 0 V. Inputs tolerate voltages up to 5.5 V independent of V_{CC} operating voltage.

Features

- Ultra-High Speed: $t_{PD} = 2.4$ ns (Typical) into 50 pF at 5 V V_{CC}
- High Output Drive: ± 24 mA at 3 V V_{CC}
- Broad V_{CC} Operating Range: 1.65 V to 5.5 V
- Matches Performance of LCX when Operated at 3.3 V V_{CC}
- Power Down High-Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra-Small MicroPak™ Packages
- Space-Saving SC-88 Package
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

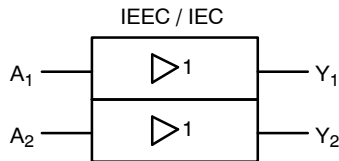
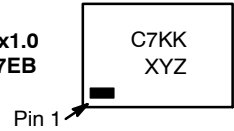


Figure 1. Logic Symbol

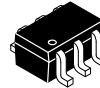
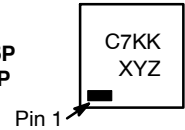
MARKING DIAGRAMS



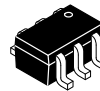
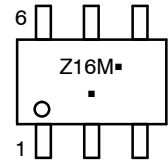
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CASE 127EB



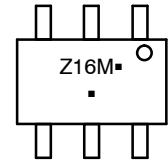
UDFN6
1.0X1.0, 0.35P
CASE 517DP



SC-88
CASE 419B-02



SC-88
CASE 419AD-01



- C7, Z16 = Specific Device Code
- KK = 2-Digit Lot Run Traceability Code
- XY = 2-Digit Date Code Format
- Z = Assembly Plant Code
- M = Assembly Operation Month
- = Pb-Free Package

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 6.

NC7WZ16

Pin Configurations

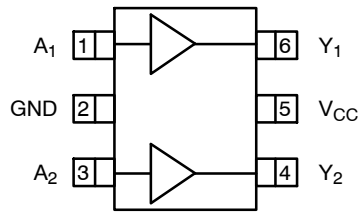


Figure 2. SC-88 (Top View)

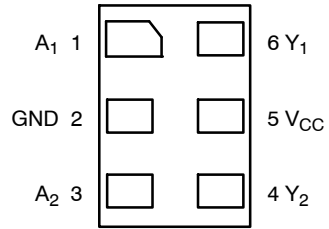
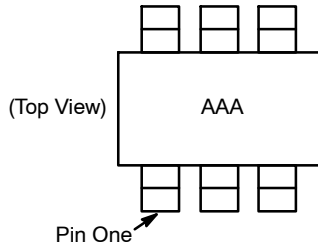


Figure 3. MicroPak (Top Through View)



NOTES:

1. AAA represents product code top mark (see ordering table).
2. Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin.

Figure 4. Pin 1 Orientation

PIN DEFINITIONS

| Pin # SC-88 | Pin # MicroPak | Name | Description |
|-------------|----------------|-----------------|----------------|
| 1 | 1 | A ₁ | Input |
| 2 | 2 | GND | Ground |
| 3 | 3 | A ₂ | Input |
| 4 | 4 | Y ₂ | Output |
| 5 | 5 | V _{CC} | Supply Voltage |
| 6 | 6 | Y ₁ | Output |

FUNCTION TABLE (Y = A)

| Inputs | Output |
|----------|----------|
| A | Y |
| L | L |
| H | H |

H = HIGH Logic Level
L LOW Logic Level

NC7WZ16

ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | | Min | Max | Unit |
|-------------------------------------|---|------------------------|------|------|------|
| V _{CC} | Supply Voltage | | -0.5 | 6.5 | V |
| V _{IN} | DC Input Voltage | | -0.5 | 6.5 | V |
| V _{OUT} | DC Output Voltage | | -0.5 | 6.5 | V |
| I _{IK} | DC Input Diode Current | V _{IN} < 0 V | - | -50 | mA |
| I _{OK} | DC Output Diode Current | V _{OUT} < 0 V | - | -50 | mA |
| I _{OUT} | DC Output Source / Sink Current | | - | ±50 | mA |
| I _{CC} or I _{GND} | DC V _{CC} or Ground Current | | - | ±100 | mA |
| T _{STG} | Storage Temperature Range | | -65 | +150 | °C |
| T _J | Junction Temperature Under Bias | | - | +150 | °C |
| T _L | Junction Lead Temperature (Soldering, 10 Seconds) | | - | +260 | °C |
| P _D | Power Dissipation in Still Air | SC-88 | - | 332 | mW |
| | | MicroPak-6 | - | 812 | |
| | | MicroPak2™-6 | - | 812 | |
| ESD | Human Body Model, JEDEC: JESD22-A114 | | - | 4000 | V |
| | Charge Device Model, JEDEC: JESD22-C101 | | - | 2000 | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------------------|-------------------------------|---------------------------------------|------|-----------------|------|
| V _{CC} | Supply Voltage Operating | | 1.65 | 5.50 | V |
| | Supply Voltage Data Retention | | 1.50 | 5.50 | |
| V _{IN} | Input Voltage | | 0 | 5.5 | V |
| V _{OUT} | Output Voltage | | 0 | V _{CC} | V |
| t _r , t _f | Input Rise and Fall Times | V _{CC} = 1.8 V, 2.5 V ±0.2 V | 0 | 20 | ns/V |
| | | V _{CC} = 3.3 V ±0.3 V | 0 | 10 | |
| | | V _{CC} = 5.5 V ±0.5 V | 0 | 5 | |
| T _A | Operating Temperature | | -40 | +125 | °C |
| θ _{JA} | Thermal Resistance | SC-88 | - | 377 | °C/W |
| | | MicroPak | - | 154 | |
| | | MicroPak2 | - | 154 | °C/W |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

3. Unused inputs must be held HIGH or LOW. They may not float.

NC7WZ16

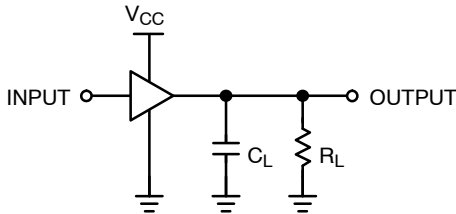
DC ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | V _{CC} (V) | Conditions | | T _A = 25°C | | | T _A = -40 to 85°C | | Unit | |
|------------------|----------------------------------|---------------------|---|---|-----------------------|------|----------------------|------------------------------|----------------------|------|------|
| | | | | | Min | Typ | Max | Min | Max | | |
| V _{IH} | HIGH Level Control Input Voltage | 1.65 to 1.95 | | | 0.65 V _{CC} | - | - | 0.65 V _{CC} | - | V | |
| | | 2.3 to 5.5 | | | 0.70 V _{CC} | - | - | 0.70 V _{CC} | - | | |
| V _{IL} | LOW Level Control Input Voltage | 1.65 to 1.95 | | | - | - | 0.35 V _{CC} | - | 0.35 V _{CC} | V | |
| | | 2.3 to 5.5 | | | - | - | 0.30 V _{CC} | - | 0.30 V _{CC} | | |
| V _{OH} | HIGH Level Output Voltage | 1.65 | V _{IN} = V _{IH} or V _{IL} | I _{OH} = -100 μA | 1.55 | 1.65 | - | 1.55 | - | V | |
| | | 1.80 | | | 1.70 | 1.80 | - | 1.70 | - | | |
| | | 2.30 | | | 2.20 | 2.30 | - | 2.20 | - | | |
| | | 3.00 | | | 2.90 | 3.00 | - | 2.90 | - | | |
| | | 4.50 | | | 4.40 | 4.50 | - | 4.40 | - | | |
| | | 1.65 | | I _{OH} = -4 mA | | 1.29 | 1.52 | - | 1.29 | | - |
| | | 2.30 | | I _{OH} = -8 mA | | 1.90 | 2.14 | - | 1.90 | | - |
| | | 3.00 | | I _{OH} = -16 mA | | 2.40 | 2.75 | - | 2.40 | | - |
| | | 3.00 | | I _{OH} = -24 mA | | 2.30 | 2.62 | - | 2.30 | | - |
| | | 4.50 | | I _{OH} = -32 mA | | 3.80 | 4.13 | - | 3.80 | | - |
| V _{OL} | LOW Level Output Voltage | 1.65 | V _{IN} = V _{IH} or V _{IL} | I _{OL} = 100 μA | - | 0.00 | 0.10 | - | 0.10 | V | |
| | | 1.80 | | | - | 0.00 | 0.10 | - | 0.10 | | |
| | | 2.30 | | | - | 0.00 | 0.10 | - | 0.10 | | |
| | | 3.00 | | | - | 0.00 | 0.10 | - | 0.10 | | |
| | | 4.50 | | | - | 0.00 | 0.10 | - | 0.10 | | |
| | | 1.65 | | I _{OL} = 4 mA | | - | 0.08 | 0.24 | - | | 0.24 |
| | | 2.30 | | I _{OL} = 8 mA | | - | 0.10 | 0.30 | - | | 0.30 |
| | | 3.00 | | I _{OL} = 16 mA | | - | 0.16 | 0.40 | - | | 0.40 |
| | | 3.00 | | I _{OL} = 24 mA | | - | 0.24 | 0.55 | - | | 0.55 |
| | | 4.50 | | I _{OL} = 32 mA | | - | 0.25 | 0.55 | - | | 0.55 |
| I _{IN} | Input Leakage Current | 1.65 to 5.5 | | 0 ≥ V _{IN} ≥ 5.5 V | - | - | ±0.1 | - | ±1.0 | μA | |
| I _{OFF} | Power Off Leakage Current | 0 | | V _{IN} or V _{OUT} = 5.5 V | - | - | 1.0 | - | 10 | μA | |
| I _{CC} | Quiescent Supply Current | 1.65 to 5.50 | | V _{IN} = 5.5 V, GND | - | - | 1.0 | - | 10 | μA | |

AC ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | V _{CC} (V) | Conditions | T _A = 25°C | | | T _A = -40 to 85°C | | Unit |
|-------------------------------------|--|---------------------|---|-----------------------|-----|-----|------------------------------|------|------|
| | | | | Min | Typ | Max | Min | Max | |
| t _{PLH} , t _{PHL} | Propagation Delay (Figure 5, 6) | 1.65 | C _L = 15 pF, R _L = 1 MΩ | - | 5.5 | 9.6 | - | 10.6 | ns |
| | | 1.80 | | - | 4.6 | 8.0 | - | 8.8 | |
| | | 2.50 ±0.20 | | - | 3.0 | 5.2 | - | 5.8 | |
| | | 3.30 ±0.30 | | - | 2.3 | 3.6 | - | 4.0 | |
| | | 5.00 ±0.50 | | - | 1.8 | 2.9 | - | 3.2 | |
| | | 3.30 ±0.30 | C _L = 50 pF, R _L = 500 Ω | - | 3.0 | 4.6 | - | 5.1 | |
| | | 5.00 ±0.50 | | - | 2.4 | 3.8 | - | 4.2 | |
| C _{IN} | Input Capacitance | 0 | | - | 2.5 | - | - | - | pF |
| C _{PD} | Power Dissipation Capacitance (Note 4) (Figure 7) | 3.30 | | - | 10 | - | - | - | pF |
| | | 5.00 | | - | 12 | - | - | - | |

4. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression:
 $I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CCstatic})$.



NOTE:
 5. C_L includes load and stray capacitance;
 inputs PRR = 1.0 MHz, t_w = 500 ns.

Figure 5. AC Test Circuit

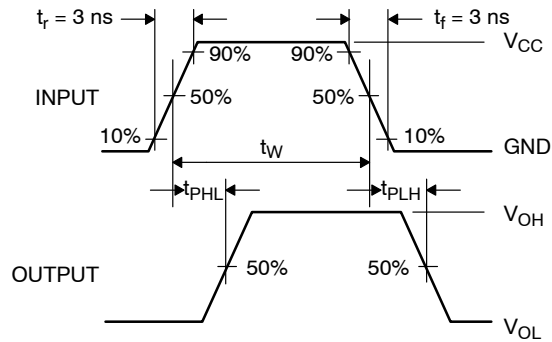
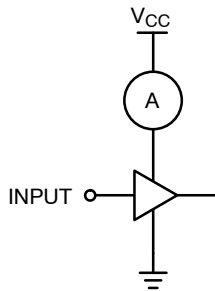


Figure 6. AC Waveforms



NOTE:
 6. Input = AC Waveform; t_r = t_f = 1.8 ns;
 PRR = 10 MHz; Duty Cycle = 50%.

Figure 7. I_{CCD} Test Circuit

NC7WZ16

DEVICE ORDERING INFORMATION

| Device | Top Mark | Packages | Shipping† |
|------------|----------|--|--------------------|
| NC7WZ16P6X | Z16 | 6-Lead SC70, EIAJ SC-88, 1.25 mm Wide | 3000 / Tape & Reel |
| NC7WZ16L6X | C7 | 6-Lead MicroPak, 1.00 mm Wide | 5000 / Tape & Reel |
| NC7WZ16FHX | C7 | 6-Lead, MicroPak2, 1x1 mm Body, .35 mm Pitch | 5000 / Tape & Reel |

DISCONTINUED (Note 7)

| | | | |
|-------------------|-----|--|--------------------|
| NC7WZ16P6X-L22347 | Z16 | 6-Lead SC70, EIAJ SC-88, 1.25 mm Wide | 3000 / Tape & Reel |
| NC7WZ16L6X-L22175 | C7 | 6-Lead MicroPak, 1.00 mm Wide | 5000 / Tape & Reel |
| NC7WZ16FHX-L22175 | C7 | 6-Lead, MicroPak2, 1x1 mm Body, .35 mm Pitch | 5000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

7. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on www.onsemi.com.

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MECHANICAL CASE OUTLINE

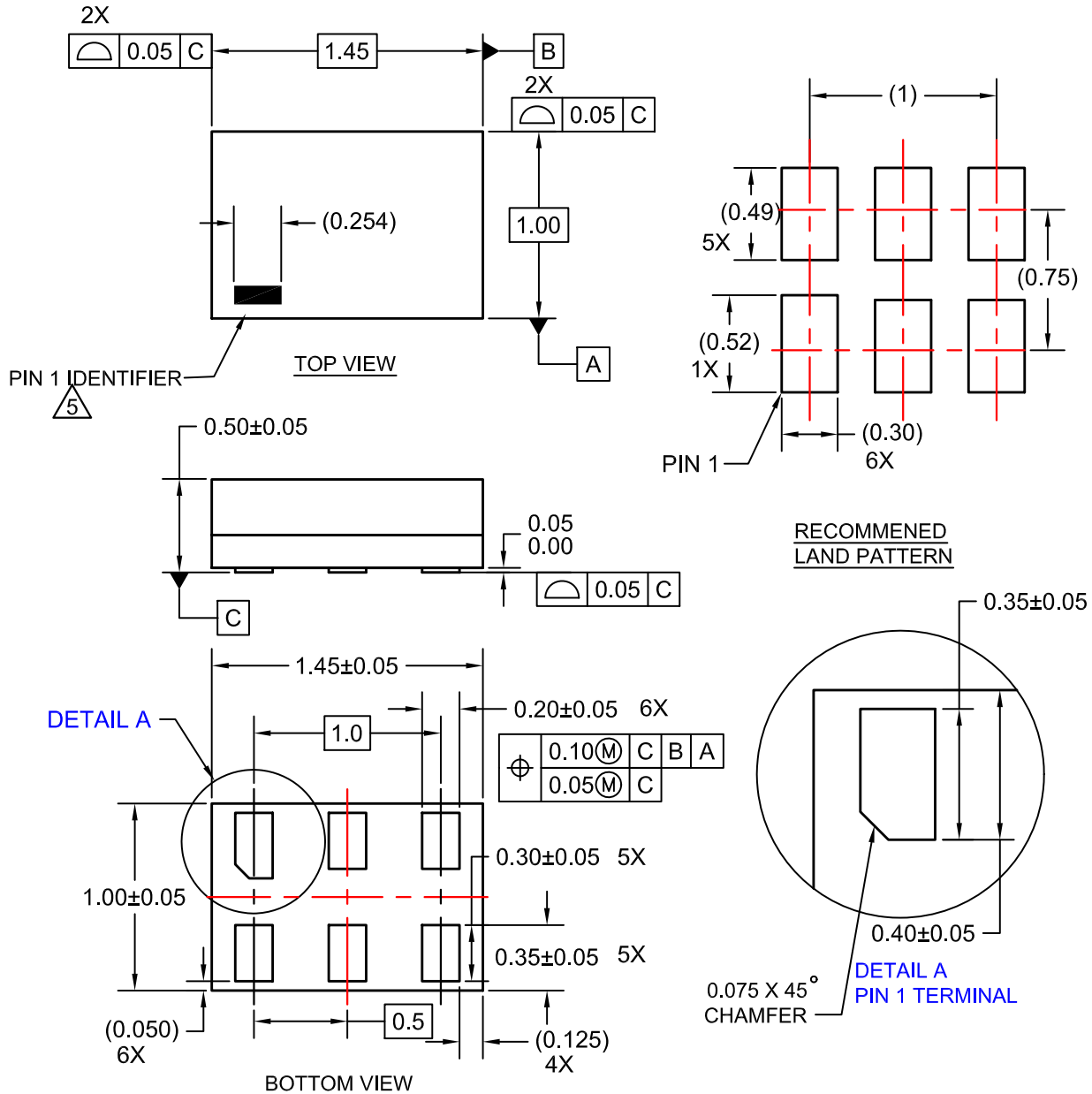
PACKAGE DIMENSIONS

ON Semiconductor®



SIP6 1.45X1.0
CASE 127EB
ISSUE O

DATE 31 AUG 2016

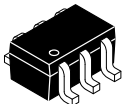


NOTES:

1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-2009
4. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY OTHER LINE IN THE MARK CODE LAYOUT.

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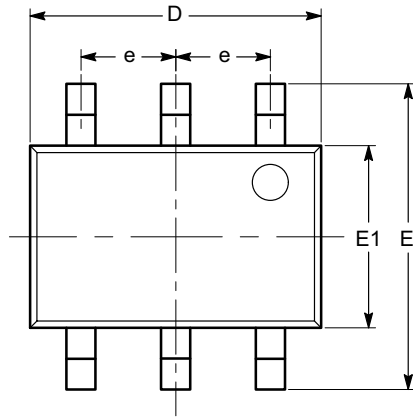
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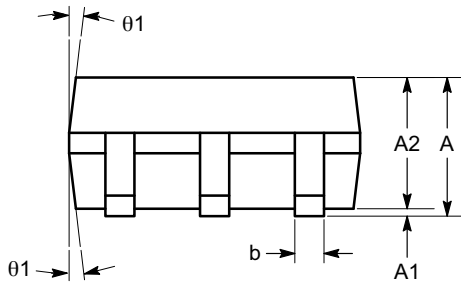
SC-88 (SC-70 6 Lead), 1.25x2
CASE 419AD
ISSUE A

DATE 07 JUL 2010

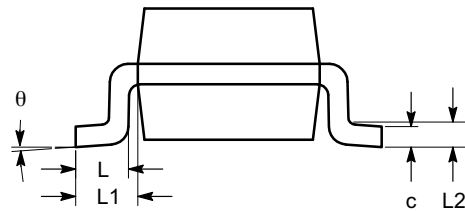


TOP VIEW

| SYMBOL | MIN | NOM | MAX |
|------------|----------|------|------|
| A | 0.80 | | 1.10 |
| A1 | 0.00 | | 0.10 |
| A2 | 0.80 | | 1.00 |
| b | 0.15 | | 0.30 |
| c | 0.10 | | 0.18 |
| D | 1.80 | 2.00 | 2.20 |
| E | 1.80 | 2.10 | 2.40 |
| E1 | 1.15 | 1.25 | 1.35 |
| e | 0.65 BSC | | |
| L | 0.26 | 0.36 | 0.46 |
| L1 | 0.42 REF | | |
| L2 | 0.15 BSC | | |
| θ | 0° | | 8° |
| θ_1 | 4° | | 10° |



SIDE VIEW



END VIEW

Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-203.

| | | |
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| DESCRIPTION: | SC-88 (SC-70 6 LEAD), 1.25X2 | PAGE 1 OF 1 |

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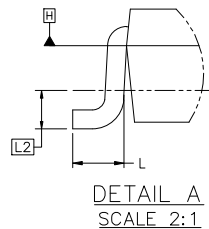
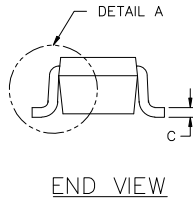
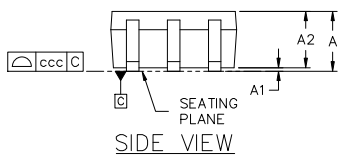
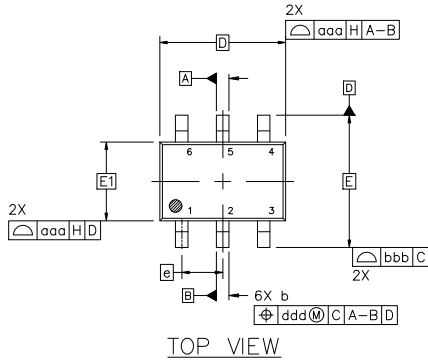


SC-88 2.00x1.25x0.90, 0.65P
CASE 419B-02
ISSUE Z

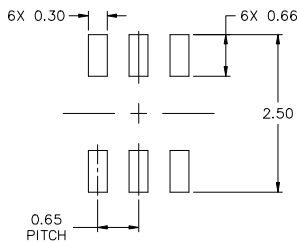
DATE 18 APR 2024

NOTES:

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018.
2. ALL DIMENSION ARE IN MILLIMETERS.
3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END.
4. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H.
5. DATUMS A AND B ARE DETERMINED AT DATUM H.
6. DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.
7. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION b AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

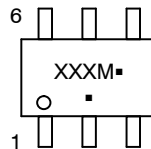


| DIM | MILLIMETERS | | |
|-----|-------------|------|------|
| | MIN. | NOM. | MAX. |
| A | --- | --- | 1.10 |
| A1 | 0.00 | --- | 0.10 |
| A2 | 0.70 | 0.90 | 1.00 |
| b | 0.15 | 0.20 | 0.25 |
| c | 0.08 | 0.15 | 0.22 |
| D | 2.00 BSC | | |
| E | 2.10 BSC | | |
| E1 | 1.25 BSC | | |
| e | 0.65 BSC | | |
| L | 0.26 | 0.36 | 0.46 |
| L2 | 0.15 BSC | | |
| aaa | 0.15 | | |
| bbb | 0.30 | | |
| ccc | 0.10 | | |
| ddd | 0.10 | | |



* FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code
M = Date Code*
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

STYLES ON PAGE 2

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SC-88 2.00x1.25x0.90, 0.65P
CASE 419B-02
ISSUE Z

DATE 18 APR 2024

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|--|--|---|---|---|---|
| STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2 | STYLE 2: CANCELLED | STYLE 3: CANCELLED | STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE | STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE | STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2 |
| STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2 | STYLE 8: CANCELLED | STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2 | STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2 | STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2 | STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2 |
| STYLE 13: PIN 1. ANODE 2. N/C 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE | STYLE 14: PIN 1. VREF 2. GND 3. GND 4. IOUT 5. VEN 6. VCC | STYLE 15: PIN 1. ANODE 1 2. ANODE 2 3. ANODE 3 4. CATHODE 3 5. CATHODE 2 6. CATHODE 1 | STYLE 16: PIN 1. BASE 1 2. EMITTER 2 3. COLLECTOR 2 4. BASE 2 5. EMITTER 1 6. COLLECTOR 1 | STYLE 17: PIN 1. BASE 1 2. EMITTER 1 3. COLLECTOR 2 4. BASE 2 5. EMITTER 2 6. COLLECTOR 1 | STYLE 18: PIN 1. VIN1 2. VCC 3. VOUT2 4. VIN2 5. GND 6. VOUT1 |
| STYLE 19: PIN 1. IOUT 2. GND 3. GND 4. V CC 5. V EN 6. V REF | STYLE 20: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER 5. COLLECTOR 6. COLLECTOR | STYLE 21: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. N/C 6. CATHODE 1 | STYLE 22: PIN 1. D1 (i) 2. GND 3. D2 (i) 4. D2 (c) 5. VBUS 6. D1 (c) | STYLE 23: PIN 1. Vn 2. CH1 3. Vp 4. N/C 5. CH2 6. N/C | STYLE 24: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE |
| STYLE 25: PIN 1. BASE 1 2. CATHODE 3. COLLECTOR 2 4. BASE 2 5. EMITTER 6. COLLECTOR 1 | STYLE 26: PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2 4. SOURCE 2 5. GATE 2 6. DRAIN 1 | STYLE 27: PIN 1. BASE 2 2. BASE 1 3. COLLECTOR 1 4. EMITTER 1 5. EMITTER 2 6. COLLECTOR 2 | STYLE 28: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN | STYLE 29: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE/ANODE 6. CATHODE | STYLE 30: PIN 1. SOURCE 1 2. DRAIN 2 3. DRAIN 2 4. SOURCE 2 5. GATE 1 6. DRAIN 1 |

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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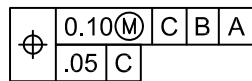
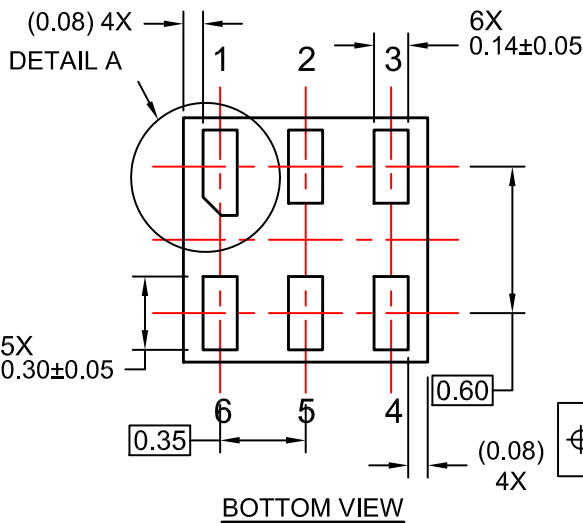
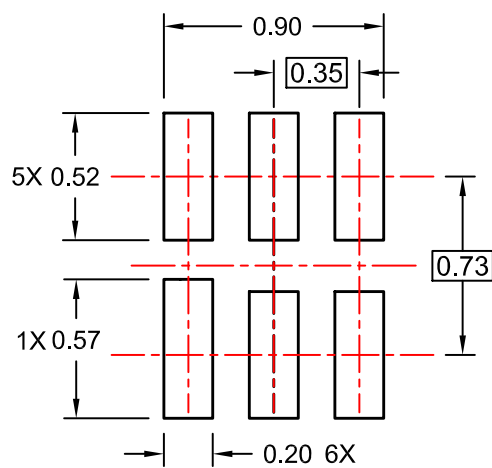
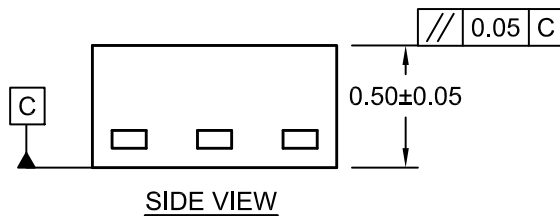
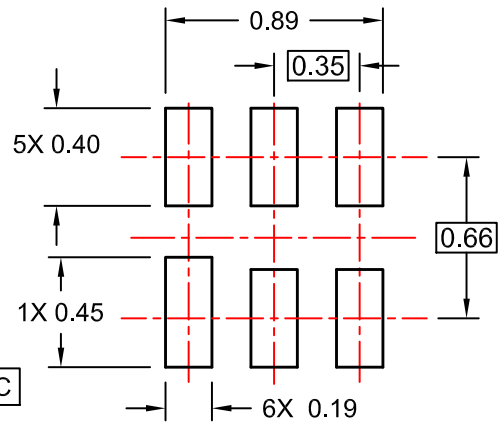
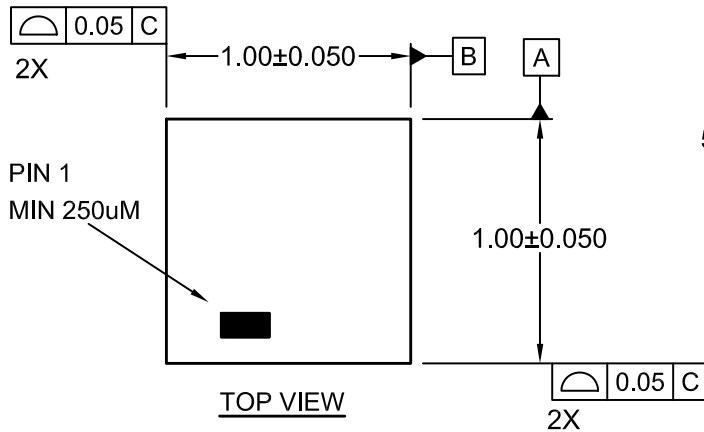
MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

ON Semiconductor®



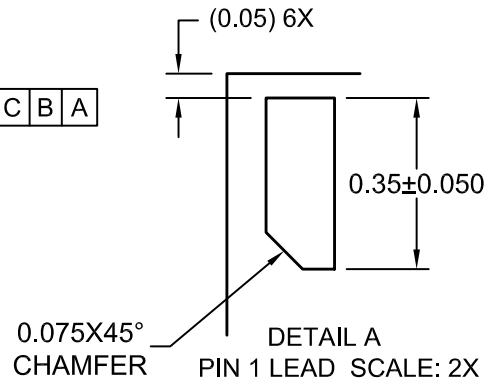
UDFN6 1.0X1.0, 0.35P
CASE 517DP
ISSUE O

DATE 31 AUG 2016



NOTES:

- A. COMPLIES TO JEDEC MO-252 STANDARD
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009



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